

### **GENERAL DESCRIPTION**

OB2532A is a primary side regulation off-line LED lighting controller which can achieve accurate LED current. It significantly simplifies LED lighting system design by eliminating the secondary side feedback circuitry. Proprietary Constant Voltage (CV) and Constant Current (CC) control is integrated as shown in the figure below.

The LED current (CC control) can be adjusted externally by the resistor Rs at CS pin. Device operates in PFM in CC mode as well at large load condition and it operates in PWM with frequency reduction at light/medium load.

OB2532A offers comprehensive protection coverage with auto-recovery features including Cycle-by-Cycle current limiting, VDD OVP, VDD clamp and UVLO. Excellent EMI performance is achieved with On-Bright proprietary frequency shuffling technique.

OB2532A is offered in SOT23-6 package.

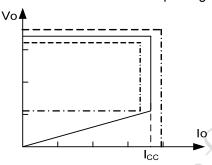


Fig.1. Typical CC/CV Curve

#### **FEATURES**

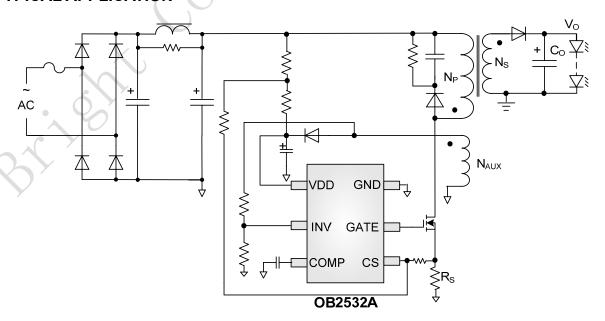
- High Precise Constant Current Regulation at Universal AC input
- Primary-side Sensing and Regulation Without TL431 and Opto-coupler
- Programmable CC Regulation
- Adjustable Constant Current and Output Power Setting
- Built-in Secondary Constant Current Control with Primary Side Feedback
- Built-in Adaptive Current Peak Regulation
- Built-in Primary winding inductance compensation
- Power on Soft-start
- Built-in Leading Edge Blanking (LEB)
- Cycle-by-Cycle Current Limiting
- VDD Under Voltage Lockout with Hysteresis (UVLO)
- VDD OVP
- VDD Clamp

## **APPLICATIONS**

Low Power AC/DC offline SMPS for

LED applications

### TYPICAL APPLICATION

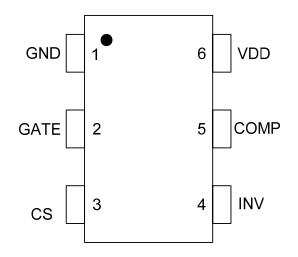




## **GENERAL INFORMATION**

### **Pin Configuration**

The pin map is shown as below for SOT23-6.



**Ordering Information** 

Part Number	Description
OB2532AMP	SOT23-6, Pb-free, T&R

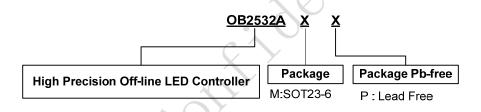
**Package Dissipation Rating** 

Package	RθJA (℃/W)
SOT23-6	200

**Absolute Maximum Ratings** 

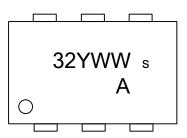
Absolute Maximum Natings				
Parameter	Value			
VDD Voltage	-0.3 to V <sub>DD</sub> _clamp			
VDD Zener Clamp	10 mA			
Continuous Current	TOTHA			
COMP Voltage	-0.3 to 7V			
CS Input Voltage	-0.3 to 7V			
INV Input Voltage	-0.3 to 7V			
Min/Max Operating	-40 to 150 ℃			
Junction Temperature T <sub>J</sub>	-40 to 150 C			
Min/Max Storage	-55 to 150 ℃			
Temperature T <sub>stg</sub>	-55 to 150 C			
Lead Temperature	260 ℃			
(Soldering, 10secs)	200 C			

**Note:** Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute maximum-rated conditions for extended periods may affect device reliability.





# **Marking Information**



Y: Year Code

WW: Week Code(01-52)

A:Character Code

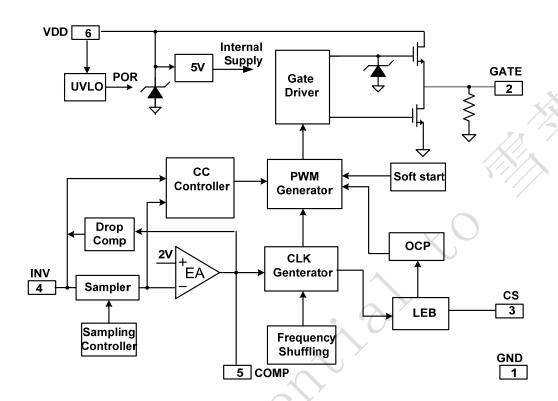
S: Internal Code(Optional)

## **TERMINAL ASSIGNMENTS**

Pin Num	Pin Name	I/O	Description
1	GND	Р	Ground
2	GATE	0	Totem-pole gate drive output for power MOSFET.
3	CS	I	Current sense input. Connected to MOSFET current sensing resistor node.
4	INV	ı	The voltage feedback from auxiliary winding. Connected to resistor divider from auxiliary winding reflecting output voltage. PWM duty cycle is determined by EA output and current sense signal at pin 3.
5	COMP	ı	Loop Compensation for CV Stability
6	VDD	Р	Power Supply



### **BLOCK DIAGRAM**





## **ELECTRICAL CHARACTERISTICS**

(TA = 25°C, VDD=VDDG=16V, if not otherwise noted)

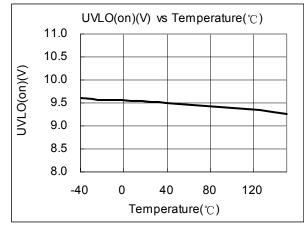
Symbol	Parameter	Test Conditions	Min	Тур	Max	Unit
Supply Voltage	(VDD) Section		•	•	•	N
I <sub>DD ST</sub>	Standby Current	VDD=13V		5	20	uA
I <sub>DD op</sub>	Operation Current	Operation supply current INV=2V, CS=0V, VDD=VDDG=20V	-	2	3	mA
UVLO(ON)	VDD Under Voltage Lockout Enter	VDD falling	8.6	9.4	10.6	V
UVLO(OFF)	VDD Under Voltage Lockout Exit	VDD rising	13.9	15.2	16.4	V
V <sub>DD</sub> _clamp	Maximum VDD operation voltage	I <sub>DD</sub> =10mA	27	28.5	30	V
OVP	Over voltage protection Threshold	Ramp VDD until gate shut down	26	27.5	29	V
<b>Current Sense</b>	Input Section		•	•	•	
TLEB	LEB time	. 7		625		ns
Vth_oc	Over current threshold		787	800	813	mV
Td_oc	OCP Propagation delay			110		ns
Z <sub>SENSE</sub> _IN	Input Impedance	1	50			Kohm
T_ss	Soft start time	<u>ر</u> ر		17		ms
Frequency Sec	tion	Y	•		•	
Freq_Max <sup>Note 1</sup>	IC Maximum frequency		60	65	70	KHz
Freq_Nom	System Nominal switch frequency			50		KHz
Freq_startup	tup INV=0V, Comp=5V			14		KHz
△f/Freq	Frequency shuffling range			+/-6		%
Error Amplifier	section					
Vref_EA	Reference voltage for EA		1.96	2	2.04	V
Gain	DC gain of EA			60		dB
Gate Drive Out	out Section		•			
VOL	Output Low Level	VDD=16V, lo=20mA			1	V
VOH	Output High Level	VDD=16V, Io=20mA	8			V
V_clamp	Output Clamp Voltage Level			16		V
T_r	Output Rising Time	VDD=16V, CL=0.5nF		650		nS
,T_f	Output Falling Time	VDD=16V, CL=0.5nF		40		nS

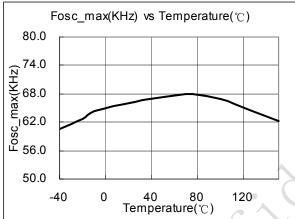
## Note:

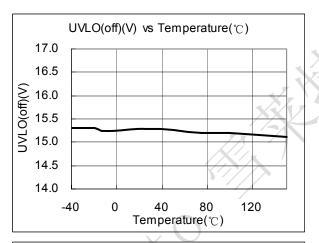
<sup>1.</sup> Freq $\_$ Max indicates IC internal maximum clock frequency. In system application, the maximum operation frequency of 65Khz nominal occurs at maximum output power or the transition point from CV to CC.

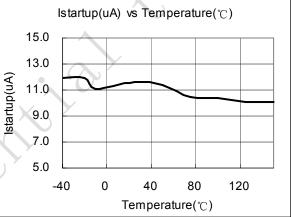


### **CHARACTERIZATION PLOTS**











#### **OPERATION DESCRIPTION**

OB2532A is a cost effective PWM controller optimized for off-line LED lighting applications which can achieve LED current. Based on flyback converter topology working in DCM mode, It operates in primary side sensing and regulation, thus opto-coupler and TL431 are not required. Proprietary built-in CC control can achieve high precision LED current meeting LED lighting application requirements.

#### Startup Current and Start up Control

Startup current of OB2532A is designed to be very low so that VDD could be charged up above UVLO threshold and starts up quickly. A large value startup resistor can therefore be used to minimize the power loss in application.

### Operating Current

The Operating current of OB2532A is as low as 2.0mA. Good efficiency is achieved with the low operating current together with 'Muti-mode' control features.

#### Soft Start

OB2532A features an internal soft start to minimize the component electrical over-stress during power on startup. As soon as VDD reaches UVLO (OFF), the control algorithm will ramp peak current voltage threshold gradually from nearly zero to normal setting of 0.8V. Every restart is a soft start.

### • Principle of CC Operation

To support OB2532A proprietary CC control, system needs to be designed in DCM mode for flyback system (Refer to Typical Application Diagram on page1). The LED output current  $I_{\text{LED}}$  is given by:

$$I_{LED} = \frac{1}{2} L_P \cdot F_{SW} \cdot I_{PK}^2 \cdot \eta / V_O \tag{1}$$

Where Lp indicates the inductance of primary winding and lpk is the peak current of primary winding.

Refer to the equation 1, the change of the primary winding inductance results in the change of the constant output current. To compensate the change from variations of primary winding inductance, the switching frequency is locked by an internal loop such that the switching frequency is

$$F_{SW} = \frac{1}{2T_{Demag}} \tag{2}$$

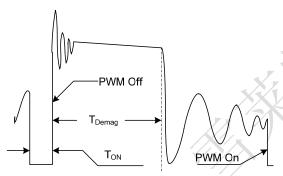


Figure 1 Auxiliary voltage waveform

Since  $T_{\text{Demag}}$  is inversely proportional to the inductance, as a result, the product Lp and fsw is constant, thus output current will not change as primary winding inductance changes. Up to  $\pm 7\%$  variation of the primary winding inductance can be compensated.

The output LED current is

$$I_{LED} = \frac{1}{4} \cdot N \cdot \frac{V_{th\_oc}}{R_c} \tag{3}$$

Where N is the ratio of transformer between primary side winding and secondary winding.

#### Adjustable CC point and Output Power

In OB2532A, the CC point and maximum output power can be externally adjusted by external current sense resistor Rs at CS pin as illustrated in Typical Application Diagram. The output power is adjusted through CC point change. The larger Rs, the smaller CC point is, and the smaller output power becomes, and vice versa as shown in Fig.3.

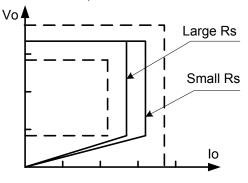


Fig.3 Adjustable output power by changing Rs

## Operation switching frequency

The switching frequency of OB2532A is adaptively controlled according to the load conditions and the operation modes. No external frequency setting components are required. The operation switching frequency at maximum output power is set to 65K Hz internally.



For flyback operating in DCM, The maximum output power is given by

$$P_{O\,\text{max}} = \frac{1}{2} \eta L_P F_{SW} I_{pk}^2 \tag{4}$$

Where Lp indicate the inductance of primary winding and Ip is the peak current of primary winding.

Refer to the equation 3, the change of the primary winding inductance results in the change of the maximum output power and the constant output current in CC mode. To compensate the change from variations of primary winding inductance, the switching frequency is locked by an internal loop such that the switching frequency is

$$F_{SW} = \frac{1}{2T_{Demag}}$$

(4)

Since  $T_{Demag}$  is inversely proportional to the inductance, as a result, the product Lp and fsw is constant, thus the maximum output power and constant current in CC mode will not change as primary winding inductance changes. Up to +/-7% variation of the primary winding inductance can be compensated.

## Frequency shuffling for EMI improvement

The frequency shuffling (switching frequency modulation) is implemented in OB2532A. The oscillation frequency is modulated so that the tone energy is spread out. The spread spectrum minimizes the conduction band EMI and therefore eases the system design.

### Current Sensing and Leading Edge Blanking

Cycle-by-Cycle current limiting is offered in OB2532A. The switch current is detected by a sense resistor into the CS pin. An internal leading edge blanking circuit chops off the sensed voltage spike at initial power MOSFET on state so that the external RC filtering on sense input is no longer needed. The PWM duty cycle is determined by the current sense input voltage and the EA output voltage.

#### Gate Drive

The external power MOSFET is driven by a dedicated gate driver of OB2532A. Too weak the gate drive strength results in higher conduction and switch loss of MOSFET while too strong gate drive compromises EMI.

A good tradeoff is achieved through the built-in totem pole gate design with right output strength control.

### Protection Control

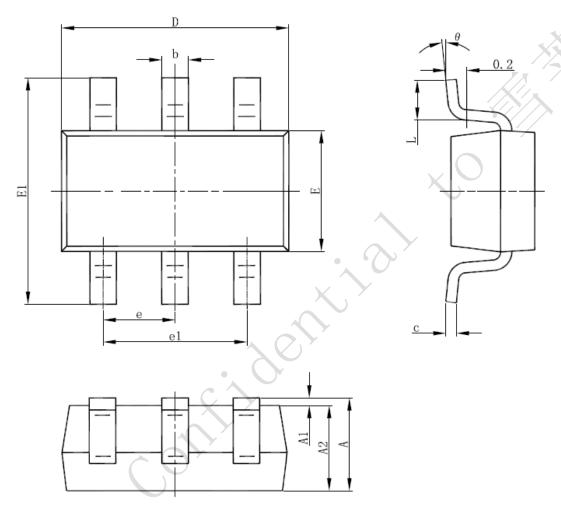
Good power supply system reliability is achieved with its rich protection features including Cycle-by-Cycle current limiting (OCP), VDD clamp, Power on Soft Start, and Under Voltage Lockout on VDD (UVLO).

VDD is supplied by transformer auxiliary winding output. The output of OB2532A is shut down when VDD drops below UVLO (ON) limit and the power converter enters power on start-up sequence thereafter.



## **PACKAGE MECHANICAL DATA**

# SOT-23-6L PACKAGE OUTLINE DIMENSIONS



Cymbol	Dimensions	In Millimeters	Dimensions In Inches		
Symbol	Min	Max	Min	Max	
Α	1.000	1.300	0.039	0.051	
A1	0.000	0.150	0.000	0.006	
A2	1.000	1.200	0.039	0.047	
b	0.300	0.500	0.012	0.020	
C	0.100	0.200	0.004	0.008	
D	2.800	3.020	0.110	0.119	
É	1.500	1.700	0.059	0.067	
E1	2.600	3.000	0.102	0.118	
е	0.950 (BSC)		0.037 (BSC)		
e1	1.800	2.000	0.071	0.079	
L	0.300	0.600	0.012	0.024	
θ	0°	8°	0°	8°	



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